

10/100 LAN Interface Module for PC Card Applications

EPF8077G



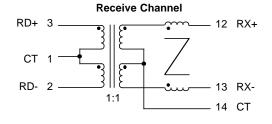
- Optimized for QSI6611/6612 PHY/MAC •
- Guaranteed to operate with 8 mA DC bias at 70°C on cable side
- Complies with or exceeds IEEE 802.3, 10 BT/100 BX Standards

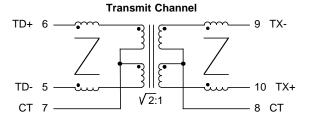
Electrical Parameters @ 25° C

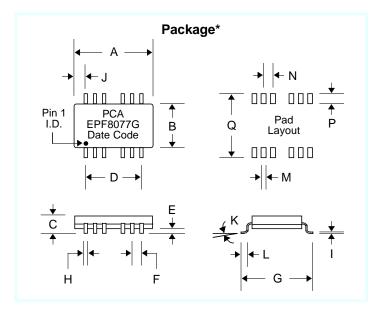
	OCL	Insertion Loss					Return Loss					Common Mode Rejection					Crosstalk (dB Min.)				
	@ 70°C	(dB Max.)					(dB Min.)					(dB Min.)					[Between Channels]				
1	00 KHz, 0.1 Vrms	1-80		100		150		1-30		60		100		30-100		200		500		5-10	10-100
	8 mA DC Bias	MHz		MHz		MHz		MHz		MHz		MHz		MHz		MHz		MHz		MHz	MHz
	Cable Side	Xmit	Rcv	Xmit	Rcv	Xmit	Rcv	Xmit	Rcv	Xmit	Rcv	Xmit	Rcv	Xmit	Rcv	Xmit	Rcv	Xmit	Rcv		
	350µH	-1	-1	-2	-2	-3.5	-3	-18	-18	-12	-12	-10	-10	-38	-38	-30	-25	-20	-15	-40	-40

• Isolation : 1500 Vrms • Cable Impedance : 100 Ω • Rise Time : 3.0 nS Max. •

Schematic







Dimensions

		(Inches))	(M	(Millimeters)					
Dim.	Min.	Max.	Nom.	Min.	Max.	Nom.				
Α	.790	.810		20.06	20.57					
В	.510	.530		12.95	13.46					
C	.078	.098		1.98	2.49					
B C D	.600	Typ.		15.24	Тур.					
F G	.003	.020		0.076	.508					
F	.100	Typ.		2.54	Тур.					
G	.660	.680		16.76	17.27					
H	.016	.022		.406	.559					
1	.008	.012		.203	.305					
J	.090	Тур.		2.28	Тур.					
K	0°	8°		0°	8°					
L	.025	.045		.635	1.14					
M			.040			1.02				
N			.100			2.54				
P			.085			2.16				
Q			.700			17.78				

* Pins 4 and 11 are absent.



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The circuit below is a guideline for interconnecting PCA's EPF8077G with QSI6611 and QSI6612 chip set for 10/100 Mb/s applications. Further details can be obtained from the chip manufacturer application notes.

Typical insertion loss of the isolation transformer is 0.5dB. This parameter covers the entire spectrum of the encoded signals in 10/100 protocols. Under terminated conditions, to transmit a 2V pk-pk signal across the cable, you must adjust the chip's supporting resistor to get at least 2.12V pk-pk across the transmit pins.

It is recommended that system designers do not use the receiver side center tap to ground, via a capacitor. This may worsen EMI, specifically if the secondary "common mode termination" is pulled to chassis ground as shown.

The phantom resistors shown around the connector have been known to suppress unwanted radiation that unused wires pick up from the immediate environment. Their placement and use are to be considered carefully before a design is finalized.

The "common mode termination" load of 75 Ω shown from the center taps of the secondary may be taken to chassis ground via a cap of suitable value. This depends upon user's design, EMI margin etc.

It is recommended that there be a neat separation of ground planes in the layout. It is generally accepted practice to limit the plane off at least 0.05 inches away from the chip side pins of EPF8077G. There need not be any ground plane beyond this point.

For best results, PCB designer should design the outgoing traces preferably to be 50 Ω , balanced and well coupled to achieve minimum radiation from these traces.

Typical Application Circuit for UTP

